

TRIACS

Also available to BS9343-F001

Silicon triacs in metal envelopes, intended for industrial a.c. power control and are particularly suitable for static switching of 3-phase induction motors. They may also be used for furnace control, lighting control and other static switching applications up to an r.m.s. on-state current of 15 A.

Two grades of commutation performance are available, 10 V/μs at 5 A/ms (suffix G) and 10 V/μs at 12 A/ms (suffix H).

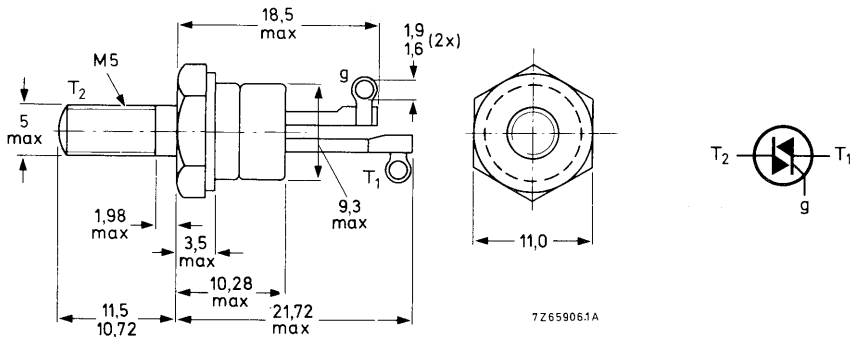
QUICK REFERENCE DATA

	BTW43-600			
	800	1000	1200	
Repetitive peak off-state voltage	V_{DRM} max. 600	800	1000	1200 V
R.M.S. on-state current	$I_T(RMS)$		max. 15 A	
Non-repetitive peak on-state current	I_{TSM}		max. 120 A	
Rate of rise of commutating voltage that will not trigger any device (see page 3)	dV_{com}/dt		<	10 V/μs

MECHANICAL DATA

Dimensions in mm

Fig. 1 TO-64: with metric M5 stud (φ 5 mm).



Net mass: 7 g
 Diameter of clearance hole: max. 5,2 mm
 Accessories supplied on request: 56295
 (PTFE bush, 2 mica washers, plain washer, tag)

Torque on nut: min. 0,9 Nm
 (9 kg cm)
 max. 1,7 Nm
 (17 kg cm)

Supplied with the device: 1 nut, 1 lock washer
 Nut dimensions across the flats: 8,0 mm

RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

Voltages (in either direction)*

Non-repetitive peak off-state voltage
($t \leq 10$ ms)

		BTW43-600	800	1000	1200
V_{DSM}	max.	600	800	1000	1200 V
V_{DRM}	max.	600	800	1000	1200 V
V_{DWM}	max.	400	600	700	800 V

Repetitive peak off-state voltage

Crest working off-state voltage

Currents (in either direction)

R.M.S. on-state current (conduction angle 360°)

up to $T_{mb} = 75^\circ\text{C}$

at $T_{mb} = 85^\circ\text{C}$

$I_{T(RMS)}$	max.	15 A
$I_{T(RMS)}$	max.	12 A

Average on-state current for half-cycle operation
(averaged over any 20 ms period)

up to $T_{mb} = 35^\circ\text{C}$

at $T_{mb} = 85^\circ\text{C}$

$I_T(AV)$	max.	9,5 A
$I_T(AV)$	max.	5,5 A

Repetitive peak on-state current

I_{TRM}	max.	50 A
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Non-repetitive peak on-state current

$T_j = 125^\circ\text{C}$ prior to surge; $t = 20$ ms; full sine-wave

I_{TSM}	max.	120 A
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$I^2 t$ for fusing ($t = 10$ ms)

$I^2 t$	max.	72 A ² s
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Rate of rise of on-state current after triggering with

$I_G = 0,5$ A to $I_T = 25$ A; $dI_G/dt = 0,5$ A/ μ s

dI_T/dt	max.	50 A/ μ s
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Gate to terminal 1

Power dissipation

Average power dissipation (averaged over any 20 ms period)

$P_{G(AV)}$	max.	1 W
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Peak power dissipation

P_{GM}	max.	10 W
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Temperatures

Storage temperature

T_{stg}	- 55 to + 125	$^\circ\text{C}$
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Junction temperature

T_j	max.	125 $^\circ\text{C}$
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THERMAL RESISTANCE

From junction to mounting base

full-cycle operation

$R_{th j-mb}$	=	2,0 $^\circ\text{C/W}$
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half-cycle operation

$R_{th j-mb}$	=	4,0 $^\circ\text{C/W}$
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From mounting base to heatsink with heatsink compound

$R_{th mb-h}$	=	0,5 $^\circ\text{C/W}$
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Transient thermal impedance; $t = 1$ ms

$Z_{th j-mb}$	=	0,2 $^\circ\text{C/W}$
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* To ensure thermal stability: $R_{th j-a} < 6$ $^\circ\text{C/W}$ (full-cycle or half-cycle operation). For smaller heatsinks $T_{j max}$ should be derated (see Figs 2 and 3).

CHARACTERISTICS

Polarities positive or negative, are identified with respect to T_1 .

Voltages (in either direction)

On-state voltage

$I_T = 20 \text{ A}; T_j = 25 \text{ }^\circ\text{C}$

$V_T < 2,2 \text{ V}^*$

Rate of rise of off-state voltage that will not trigger any device;

exponential method; $V_D = 2/3 V_{DRMmax}; T_j = 125 \text{ }^\circ\text{C}$

$dV_D/dt < 200 \text{ V}/\mu\text{s}$

Rate of rise of commutating voltage that will not trigger any device;

$I_T(\text{RMS}) = 12 \text{ A}; V_D = V_{DWMmax}; T_{mb} = 85 \text{ }^\circ\text{C}$

$dV_{com}/dt \text{ (V}/\mu\text{s)}$	$-dI_T/dt \text{ (A/ms)}$
< 10	5
< 10	12 ←

BTW43-600G to 1200G

BTW43-600H to 1200H

Currents (in either direction)

Off-state current

$V_D = V_{DWMmax}; T_j = 125 \text{ }^\circ\text{C}$

$I_D < 5 \text{ mA}$

Latching current; $T_j = 25 \text{ }^\circ\text{C}$

G positive

	$T_2 \text{ pos.}$	$T_2 \text{ neg.}$
I_L	< 200	200 mA
I_L	< 200	200 mA
I_H	< 100	100 mA

G negative

Holding current; $T_j = 25 \text{ }^\circ\text{C}$

G positive or negative

Gate to terminal 1

Voltage and current that will trigger all devices

$V_D = 12 \text{ V}; T_j = 25 \text{ }^\circ\text{C}$

G positive

$\{ V_{GT} > 2,5 \quad 5,0 \text{ V}$

$\{ I_{GT} > 100 \quad 200 \text{ mA}$

G negative

$\{ -V_{GT} > 2,5 \quad 2,5 \text{ V}$

$\{ -I_{GT} > 100 \quad 100 \text{ mA}$

Voltage that will not trigger any device

$V_D = V_{DRMmax}; T_j = 125 \text{ }^\circ\text{C}; \text{G positive or negative}$

$V_{GD} < 0,2 \quad 0,2 \text{ V}$

* Measured under pulse conditions to avoid excessive dissipation.

Fig. 2. FULL CYCLE OPERATION

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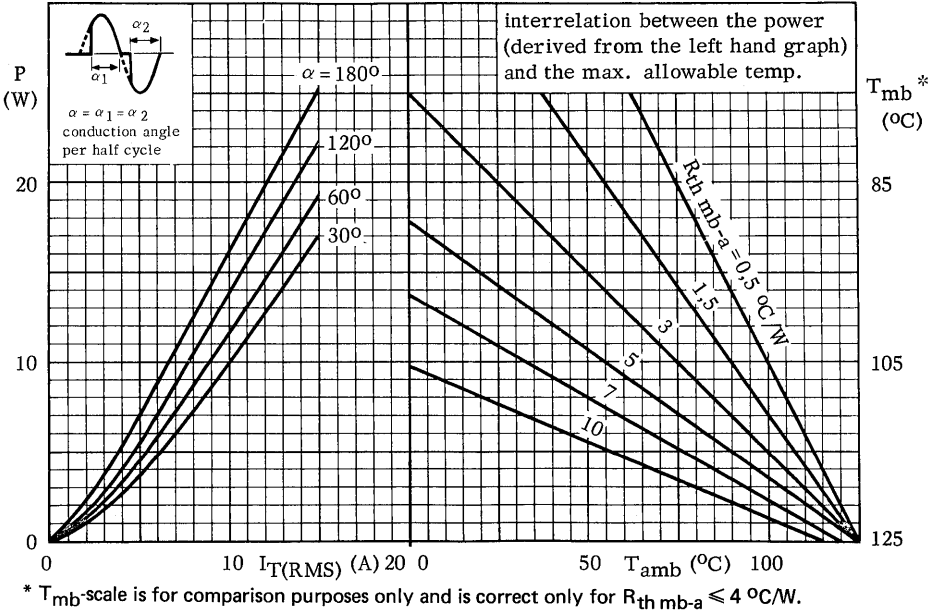
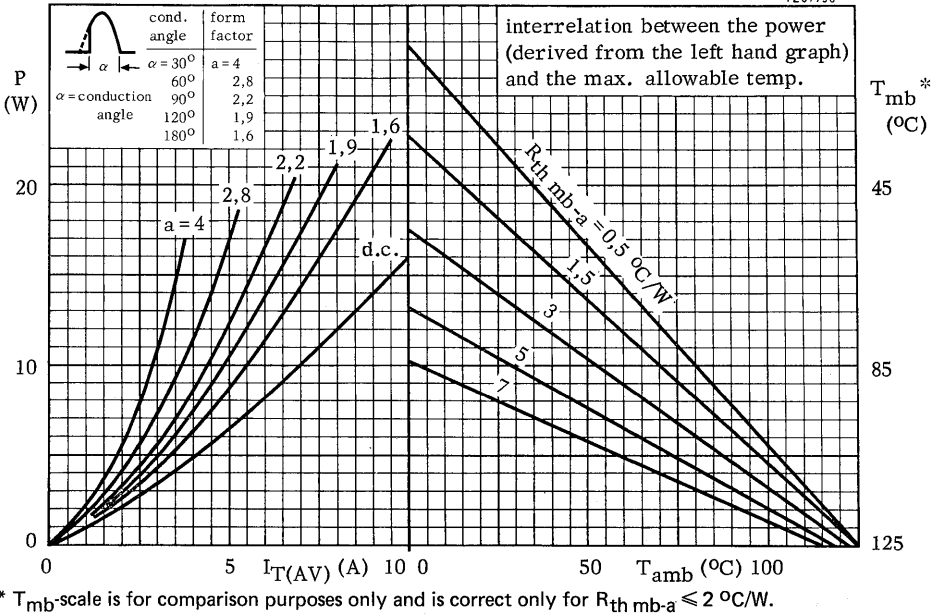
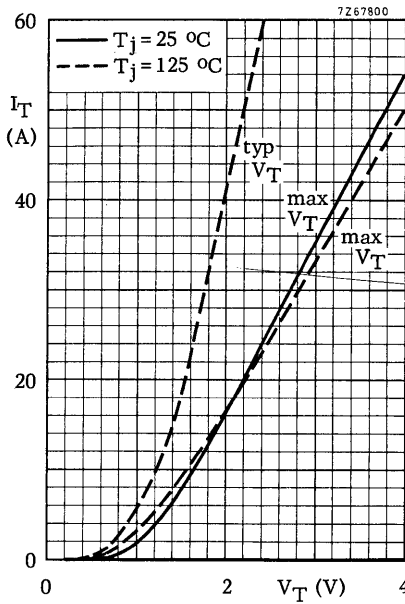
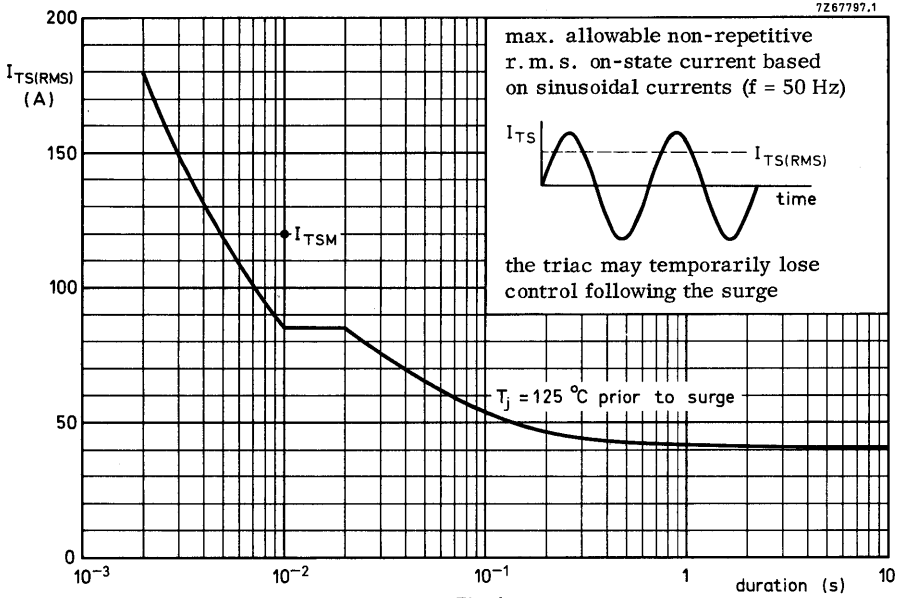


Fig. 3. HALF-CYCLE OPERATION

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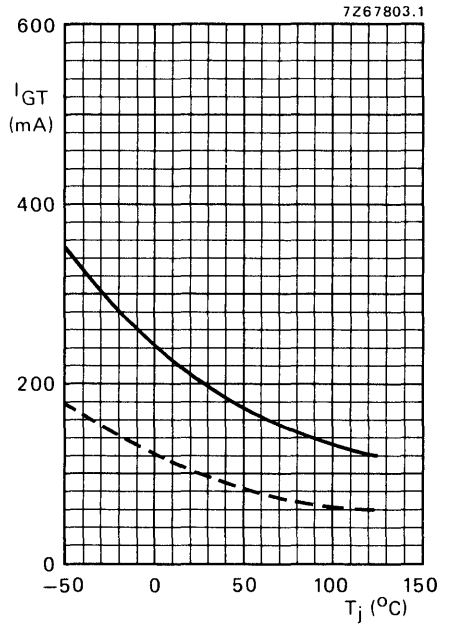
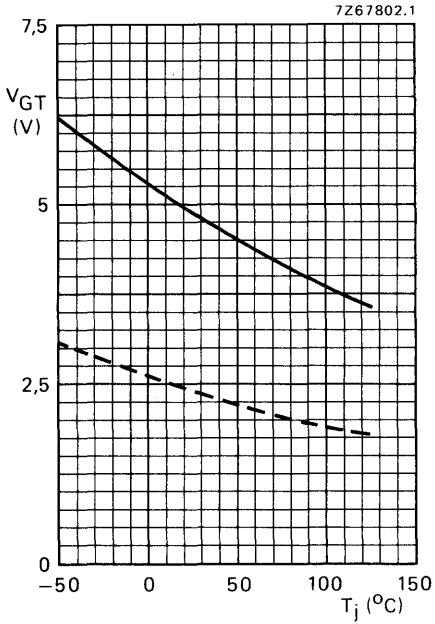


Fig. 6 Minimum gate voltage that will trigger all devices as a function of T_j .

Fig. 7 Minimum gate current that will trigger all devices as a function of T_j .

Conditions for Figs 6 and 7:

- T_2 negative, gate positive with respect to T_1
- - - all other conditions

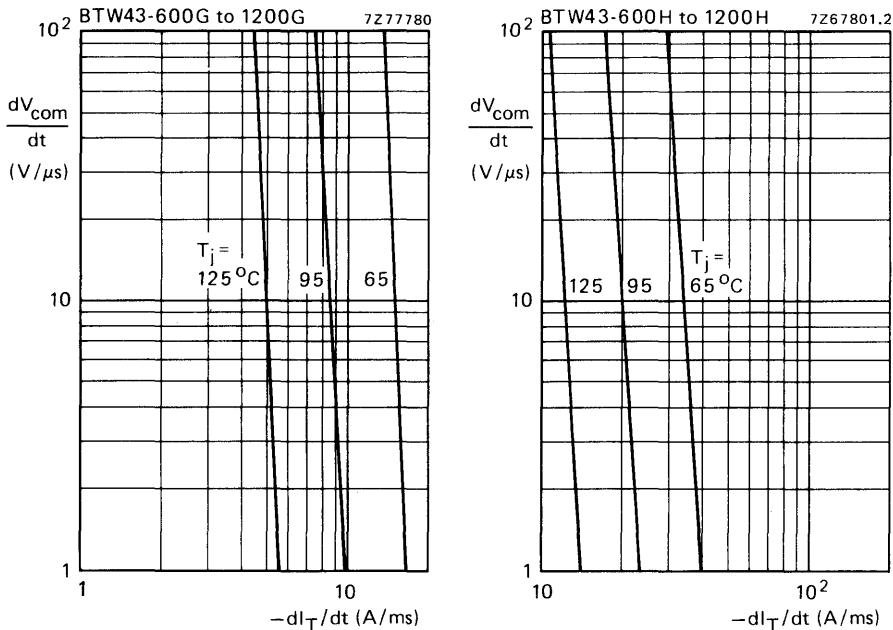


Fig. 8 Maximum rate of rise of commutating voltage that will not trigger any device as a function of rate of fall of on-state current; $I_T(\text{RMS}) = 12 \text{ A}$; $V_D = V_{DWMmax}$.

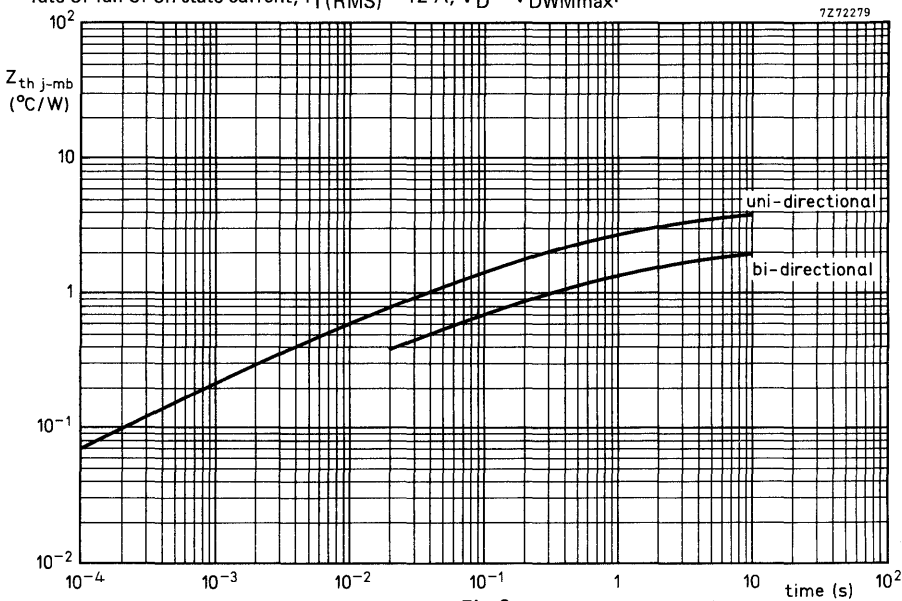


Fig. 9.

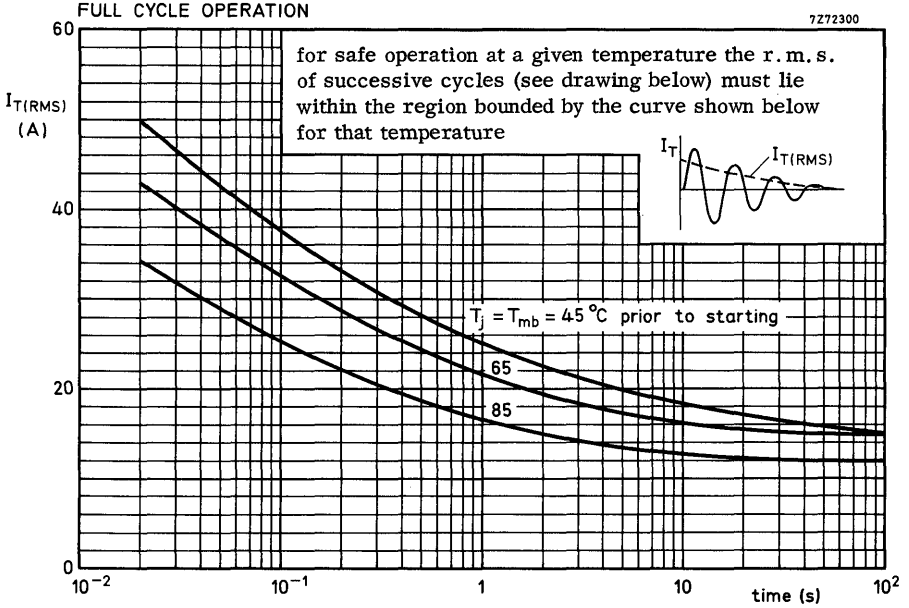


Fig. 10.

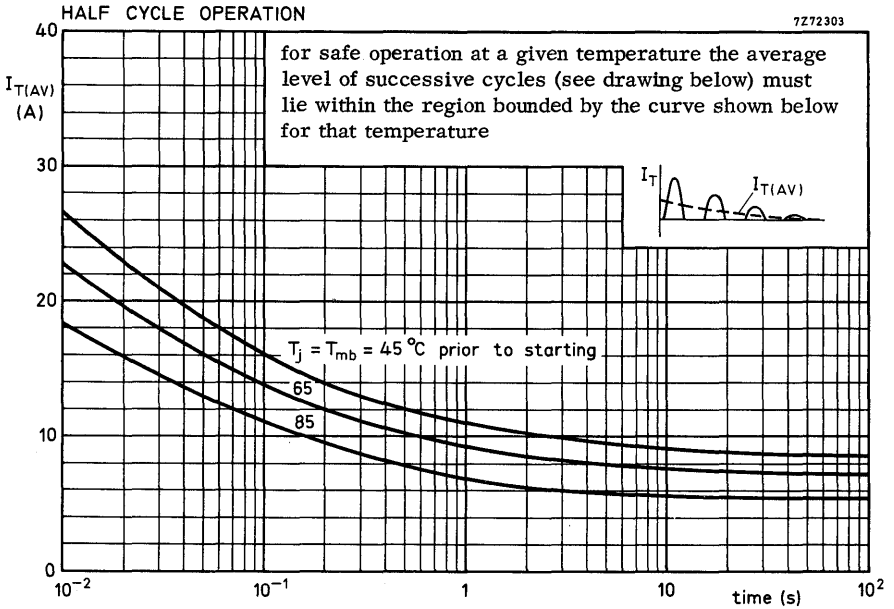


Fig. 11.